Innovative Service Around the Globe

DATA SHEET

SURFACE-MOUNT CERAMIC MULTILAYER CAPACITORS

01005

NP0/X5R/X7R 4 V TO 25 V

0.5 pF to 470 nF

RoHS compliant & Halogen Free



YAGEO Phícomp



SCOPE

This specification describes 01005 NP0/X5R series chip capacitors with lead-free terminations.

APPLICATIONS

- Mobile
- Module

FEATURES

- Supplied in tape on reel
- Nickel-barrier end termination
- RoHS compliant
- Halogen Free compliant

ORDERING INFORMATION-GLOBAL PART NUMBER, PHYCOMP

CTC & 12NC

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

YAGEO BRAND ordering code

GLOBAL PART NUMBER (PREFERRED)

CC <u>xxxx x x xxx x B x xxx</u>

(1) (2) (3) (4) (5) (6) (7)

(I) SIZE - INCH BASED (METRIC)

0100(0402)

(2) TOLERANCE

 $B = \pm 0.1 pF$

 $C = \pm 0.25 pF$

 $D = \pm 0.5 pF$

 $| = \pm 5\%$

 $K = \pm 10\%$

 $M = \pm 20\%$

(3) PACKING STYLE

R = Paper/PE taping reel; Reel 7 inch

(4) TC MATERIAL

NPO

X5R

X7R

(5) RATED VOLTAGE

 $4 = 4 \ \lor$

5 = 6.3 V

6 = 10 V

7 = 16 V

8 = 25 V

(6) PROCESS

N = NP0

B = Class 2 MLCC

(7) CAPACITANCE VALUE

2 significant digits+number of zeros

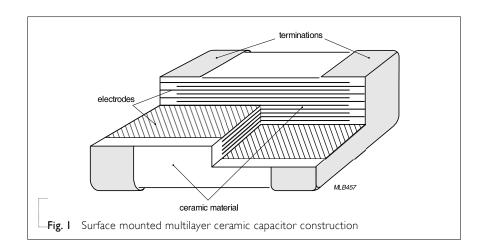
The 3rd digit signifies the multiplying factor, and letter R is decimal point

Example: $121 = 12 \times 10^{1} = 120 \text{ pF}$

CONSTRUCTION

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (NiSn). The terminations are lead-free. A cross section of the structure is shown in Fig. I.

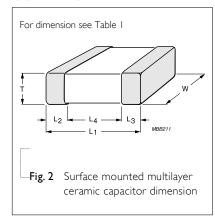


DIMENSION

Table I For outlines see fig. 2

TVDE	(NA / ()	T ()	L ₂ / L ₃	(mm)	L ₄ (mm)
TIPE	L _I (mm)	W (mm)	T (mm)	min.	max.	min.
01005	0.4 ±0.02	0.2 ±0.02	0.2 ±0.02	0.07	0.14	0.13

OUTLINES





CAPACITANCE RANGE & THICKNESS

2 010	005 Sizes			
	NP0		CAP.	
	16 V / 25 V			
5 pF	0.2±0.02		100 pF	0.2
6 pF	0.2±0.02		150 pF	0.2
7 pF	0.2±0.02		220 pF	0.2
5 pF	0.2±0.02		330 pF	0.2
8 pF	0.2±0.02		470 pF	0.2
9 pF	0.2±0.02		680 pF	0.2
0 pF	0.2±0.02		1 000 pF	0.2
2 pF	0.2±0.02		2.2 nF	0.2
5 pF	0.2±0.02		4.7 nF	0.2
8 pF	0.2±0.02		10 nF	0.2
	5 pF 6 pF 7 pF 5 pF 8 pF 9 pF 0 pF 2 pF 5 pF	16 V / 25 V 5 pF 0.2±0.02 6 pF 0.2±0.02 7 pF 0.2±0.02 5 pF 0.2±0.02 8 pF 0.2±0.02 9 pF 0.2±0.02 0 pF 0.2±0.02 2 pF 0.2±0.02 5 pF 0.2±0.02	NP0 16 V / 25 V 5 pF 0.2±0.02 6 pF 0.2±0.02 7 pF 0.2±0.02 5 pF 0.2±0.02 8 pF 0.2±0.02 9 pF 0.2±0.02 0 pF 0.2±0.02 2 pF 0.2±0.02 5 pF 0.2±0.02	NP0 CAP. 16 V / 25 V 5 pF 0.2±0.02 100 pF 6 pF 0.2±0.02 150 pF 7 pF 0.2±0.02 220 pF 5 pF 0.2±0.02 330 pF 8 pF 0.2±0.02 470 pF 9 pF 0.2±0.02 680 pF 0 pF 0.2±0.02 1 000 pF 2 pF 0.2±0.02 2.2 nF 5 pF 0.2±0.02 4.7 nF

0.2±0.02

0.2±0.02

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0.2±0.02

 0.2 ± 0.02

 0.2 ± 0.02

8 mm

2.2 pF

2.7 pF

3.3 pF

3.9 pF

4.7 pF

5.6 pF 6.8 pF

8.2 pF 10 pF

12 pF

15 pF

18 pF

22 pF

27 pF

33 pF

39 pF

47 pF

56 pF 68 pF

82 pF

100 pF

Tape width

CAP.	X5R		
	4V	6.3V	10V
100 pF	0.2±0.02	0.2±0.02	0.2±0.02
150 pF	0.2±0.02	0.2±0.02	0.2±0.02
220 pF	0.2±0.02	0.2±0.02	0.2±0.02
330 pF	0.2±0.02	0.2±0.02	0.2±0.02
470 pF	0.2±0.02	0.2±0.02	0.2±0.02
680 pF	0.2±0.02	0.2±0.02	0.2±0.02
1 000 pF	0.2±0.02	0.2±0.02	0.2±0.02
2.2 nF	0.2±0.02	0.2±0.02	0.2±0.02
4.7 nF	0.2±0.02	0.2±0.02	0.2±0.02
10 nF	0.2±0.02	0.2±0.02	0.2±0.02
22nF	0.2±0.02	0.2±0.02	
47 nF	0.2±0.02	0.2±0.02	
100 nF	0.2±0.02	0.2±0.02	0.2±0.02
220 nF	0.2±0.02	0.2±0.02	
470 nF	0.2±0.02	0.2±0.02	
Tape width		8 mm	

CAP.	X7R	
	6.3V / 10V	16V
100 pF	0.2±0.02	0.2±0.02
150 pF	0.2±0.02	0.2±0.02
220 pF	0.2±0.02	0.2±0.02
330 pF	0.2±0.02	0.2±0.02
470 pF	0.2±0.02	0.2±0.02
680 pF	0.2±0.02	0.2±0.02
1 000 pF	0.2±0.02	0.2±0.02
2.2 nF		
4.7 nF		
10 nF		
22nF		
47 nF		
100 nF		
220 nF		
Tape width	8 mr	m

THICKNESS CLASSES AND PACKING QUANTITY Table 3

YAGEO Phicomp

Table 3							
SIZE	THICKNESS	TAPE WIDTH -	Ø180 MM	1 / 7 INCH	Ø330 MM	/ 13 INCH	OUANTITY
CODE	CLASSIFICATION	=	Paper/PE	Blister	Paper/	Blister	PER BULK CASE
01005	0,2 ±0,02 mm	8 mm	20,000				

ELECTRICAL CHARACTERISTICS

NP0/X5R DIELECTRIC CAPACITORS; NISN TERMINATIONS

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C - Relative humidity: 25% to 75% - Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

 Tab	le	4	

DESCRIPT	ION	VALUE
Capacitano	e range	0.5 pF to 470 nF
Capacitano	e tolerance	
	C< 10 pF	±0.1pF, ±0.25pF, ±0.5pF
NP0	C ≥ 10 pF	±5%, ±10%
X5R / X7	R	±10%, ±20%
Dissipation	factor (D.F.)	
NP0	C < 30 pF	≤ I / (400 + 20C)
	C ≥ 30 pF	≤ 0.1 %
X5R / X7	R	≤ 10 %
Insulation r	resistance after I minute at U _r (DC)	$R_{ins} \ge 10 \text{ G}\Omega \text{ or } R_{ins} \times C \ge 500\Omega \cdot F \text{ whichever is less}$ $\times 5R/X7R > 10nF:$ $Rins \times C \ge 50\Omega \cdot F$
	capacitance change as a function of temperature ure characteristic/coefficient):	NIIS X C ≥ JUΩ · F
NP0		±30 ppm/°C
X5R / X7	R	±15%
Operating	temperature range:	
NP0		-55 °C to +125 °C
X5R		–55 °C to +85 °C
X7R		-55 °C to +125 °C

SOLDERING RECOMMENDATION

Table 5

SOLDERING SIZE METHOD 01005

Reflow Reflow only

Reflow/Wave ----

TESTS AND REQUIREMENTS

 Table 6
 Test procedures and requirements

TEST	TEST MET	HOD	PROCEDURE	REQUIREMENTS
Mounting	IEC 60384- 21/22	4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage
Visual Inspection and Dimension Check		4.4	Any applicable method using × 10 magnification	In accordance with specification
Capacitance		4.5.1	Class I: $f = I \text{ MHz for C} \le I \text{ nF, measuring at voltage } I \text{ V}_{rms} \text{ at } 20 \text{ °C}$ $f = I \text{ KHz for C} > I \text{ nF, measuring at voltage } I \text{ V}_{rms} \text{ at } 20 \text{ °C}$	Within specified tolerance
			Class 2:	
			$C \le I$ nF f = I KHz, measuring at voltage I Vrms at 20 °C	
			C > I nF $f = I$ KHz, rated voltage \leq 6.3 V, measuring at voltage 0.5 Vrms at 20 °C $f = I$ KHz, rated voltage > I0 V, measuring at voltage I Vrms at 20 °C	
Dissipation Factor (D.F.)		4.5.2	Class I: $f = I \text{ MHz for } C \leq I \text{ nF , measuring at voltage } I \text{ V}_{ms} \text{ at } 20 \text{ °C}$ $f = I \text{ KHz for } C > I \text{ nF, measuring at voltage } I \text{ V}_{ms} \text{ at } 20 \text{ °C}$	In accordance with specification
			Class 2: $C \le I \text{ nF}$ f = I KHz, measuring at voltage I Vrms at 20 °C	
			C > I nF $f = I$ KHz, rated voltage ≤ 6.3 V, measuring at voltage 0.5 Vrms at 20 °C f = I KHz, rated voltage > I0 V,	
			measuring at voltage Vrms at 20 °C	
Insulation Resistance		4.5.3	At Ur (DC) for I minute	In accordance with specification

coefficient

01005

NP0/X5RX7R

REQUIREMENTS

Class 2: (X7R/X5R):

In case of applying voltage, the capacitance change should be measured after I more min.

voltage in equilibration of each temp. stage.

CC0100MRX5R4(5)BB104(224):

Class I (NP0): $\pm 30 ppm$

with applying

0.2V±0.1Vrms

 Δ C/C

±15%

4V to 25V

1F21	LE21 WETHOD	PROCEDURE
Temperature	4.6	Capacitance sh

nall be measured by the steps shown in the following table.

The capacitance change should be measured after 5 min at each specified temperature stage.

Step	Temperature(°C)
a	25±2
Ь	Lower temperature±3°C
С	25±2
d	Upper Temperature±2℃
е	25±2

(I) Class I

Temperature Coefficient shall be calculated from the formula as below

Temp, Coefficient =
$$\frac{C2 - C1}{C1 \times \Delta T} \times 10^6 \text{ [ppm/°C]}$$

C1: Capacitance at step c

C2: Capacitance at 125℃

 ΔT : 100°C(=125°C-25°C)

Measuring Voltage: 0.5 to 5 Vrms

(2) Class II

Capacitance Change shall be calculated from the formula as below

$$\Delta C = \frac{C2 - C1}{C1} \times 100\%$$

C1: Capacitance at step c

C2: Capacitance at step b or d

Adhesion IEC 60384-

21/22

A force applied for 10 seconds to the line joining the terminations and in a plane parallel to the

substrate

Force

size 01005 : 1N

Bending Strength

4.8 Mounting in accordance with IEC 60384-22

paragraph 4.3

Conditions: bending I mm at a rate of I mm/s, radius jig 5 mm

No visible damage

 Δ C/C

Class I (NP0):

within $\pm 1\%$ or 0.5 pF, whichever is greater

Class2 (X5R/X7R):

±10%

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01005 NP0/X5RX7R 4V to 25V

TEST	TEST METH	HOD	PROCEDURE	REQUIREMENTS
Resistance to Soldering	4.9		then keep for 24 ± 1 hours at room	Dissolution of the end face plating shall not exceed 25% of the length of the edge concerned
Heat			temperature Preheating: I20 °C to I50 °C for I minute and I70 °C to 200 °C for I minute. Solder bath temperature: 260 ±5 °C Dipping time: I0 ±0.5 seconds Recovery time: 24 ±2 hours	ΔC/C Class I (NP0): within ±0.5% or 0.5 pF, whichever is greater Class2 (X5R/X7R): ±10% D.F. within initial specified value R _{ins} within initial specified value
Solderability		4.10	Preheated the temperature of 80 °C to 140 °C and maintained for 30 seconds to 60 seconds.	The solder should cover over 95% of the critical area of each termination
			Test conditions for leadfree containing solder alloy Temperature: 245 ±5 °C Dipping time: 3 ±0.3 seconds Depth of immersion: 10 mm	
Rapid Change of	IEC 60384- 21/22	4.11	Preconditioning; 150 +0/–10 °C for 1 hour, then keep for	No visual damage
Temperature			24 ±1 hours at room temperature	ΔC/C
		5 cycles with following detail: 30 minutes at lower category temperature 30 minutes at upper category temperature	,	Class I (NP0): within ±2.5% or 0.25 pF, whichever is greater
			Class2 (X5R/X7R):	
			Recovery time 24 ±2 hours	±15%
				D.F. meet initial specified value R _{ins} meet initial specified value

NP0/X5RX7R

4V to 25V

TEST TEST METHOD PROCEDURE F	REQUIREMENTS
Ur load 1. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ± 1 hour at room temp 2. Initial measure: Spec: refer initial spec C, D, IR 3. Damp heat test: 500 ± 12 hours at 40 ± 2 °C; 90 to 95% R, H; 1.0 Ur applied. 4. Recovery: Class 1: 6 to 24 hours Class 2: 24 ± 2 hours 5. Final measure: C, D, IR P.S. If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be precondition according to "IEC 60384 4.1" and then the requirement shall be met.	No visual damage after recovery Class I (NP0): $\Delta C/C$ within $\pm 7.5\%$ or 0.75 pF, whichever is greater D.F. $\leq 2 \times \text{specified value}$ I.R. $\geq 2,500 \text{ M}\Omega$ or $R_{\text{ins}} \times \text{Cr} \geq 25\Omega \cdot \text{F}$ whichever is less Class2 (X5R/X7R): $C \leq \text{InF}$ $\Delta C/C$ $\pm 15\%$ D.F. $\leq 10\%$ I.R. $\geq 500 \text{ M}\Omega$ $10\text{nF} \geq C > \text{InF}$ $\Delta C/C$ $\pm 20\%$ D.F. $\leq 10\%$ I.R. $\geq 500 \text{ M}\Omega$ $C > 10\text{nF}$ $\Delta C/C$ $\pm 20\%$ D.F. $\leq 10\%$ I.R. $\geq 500 \text{ M}\Omega$

01005

NP0/X5RX7R

4V to 25V

TEST	TEST METHOD		PROCEDURE	REQUIREMENTS
Endurance		4.14	 Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ± 1 hour at room temp Initial measure: Spec: refer initial spec C, D, IR Endurance test: Temperature: NPO: 125 °C Specified stress voltage applied for 1,000 hours:	No visual damage Class I (NP0): $\Delta C/C$ within $\pm 3\%$ or 0.3 pF, whichever is greater D.F. $\leq 2 \times \text{specified value}$ I.R. $\geq 4,000 \text{ M}\Omega \text{ or } R_{\text{ins}} \times \text{Cr} \geq 40\Omega \cdot \text{F whichever}$ is less Class2 (X5R/X7R): $C \leq \text{InF}$ $\Delta C/C$ $\pm 15\%$ D.F. $\leq 10\%$ I.R. $\geq 1G\Omega$ $10nF \geq C > \text{InF}$ $\Delta C/C$ $\pm 15\%$ D.F. $\leq 10\%$ I.R. $\geq 1G\Omega$ $C > 10nF$ $\Delta C/C$ $\pm 25\%$ D.F. $\leq 20\%$ I.R. $R_{\text{ins}} \times \text{Cr} \geq 10\Omega \cdot \text{F}$
Voltage Proof	IEC 60384-1	4.5.4	Specified stress voltage applied for 1~5 seconds	No breakdown or flashover
			Ur ≤ 100 V: series applied 2.5 Ur	
			Charge/Discharge current is less than 50 mA	

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 10	May 5, 2017	-	- Rated voltage of NPO series extend to 25 V
			- Add X5R, 470nF, 4V to 6.3V and 100nF, 10V
Version 9	Jan. 17, 2017	-	- Test condition updated
Version 8	Jan. 12, 2016	-	- Capacitance range & thickness update
Version 7	Oct. 31, 2015	-	- Capacitance range & thickness update
Version 6	Jun. 29, 2015	-	- Test procedures and requirements
Version 5	Jun. 06, 2013	-	- Test procedures and requirements
Version 4	Mar. 27, 2013	-	- Change Tolerance
Version 3	Jan. 15, 2013	-	- Change Range
Version 2	Oct. 23, 2012	-	- Change Range
Version I	July 03, 2012	-	- Change Range
Version 0	Apr 16, 2012	-	- New

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1812J1K00473KXT 1812J2K00680JCT 1812J4K00102MXT 1812J5000102JCT 1812J5000103JCT 1812J5000682JCT NIN-FB391JTRF

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KHC201E225M76N0T00 LRC-LRF1206LF-01R025FTR1K 1812J1K00222JCT 1812J2K00102KXT 1812J2K00222KXT

1812J2K00472KXT 2-1622820-7-CUT-TAPE 2220J3K00102KXT 2225J2500824KXT CCR07CG103KM CGA2B2C0G1H010C

CGA2B2C0G1H040C CGA2B2C0G1H050C CGA2B2C0G1H060D CGA2B2C0G1H070D CGA2B2C0G1H151J CGA2B2C0G1H1R5C

CGA2B2C0G1H2R2C CGA2B2C0G1H3R3C CGA2B2C0G1H680J CGA2B2C0G1H6R8D CGA2B2X8R1H221K CGA2B2X8R1H472K

CGA3E1X7R1C474K